



S2A/A - S2M/A

1.5A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 63
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (approximate)
 SMB 0.093 grams (approximate)





Top View

Bottom View

Ordering Information (Note 3)

| Part Number | Case | Packaging |
|-------------|------|------------------|
| S2xA-13-F | SMA | 5000/Tape & Reel |
| S2x-13-F | SMB | 3000/Tape & Reel |

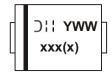
^{*}x = Device type, e.g. S2AA-13-F (SMA package); S2A-13-F (SMB package).

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



xxx = Product type marking code, ex: S2A (SMB package)
xxxx = Product type marking code, ex: S2AA (SMA package)

311 = Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year (ex: 2 for 2002)
WW = Week code (01 to 53)



Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

| Characteristic | Symbol | S2 A/AA | S2 B/BA | S2 D/DA | S2 G/GA | S2 J/JA | S2 K/KA | S2 M/MA | Unit |
|---|-----------------------------|------------|------------|------------|------------|------------|------------|------------|-------------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | $V_{RRM} \ V_{RWM} \ V_{R}$ | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | > |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Output Current @ T _T = 100°C | I _(AV) | | | | 1.5 | | | | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | | | | 50 | | | | Α |

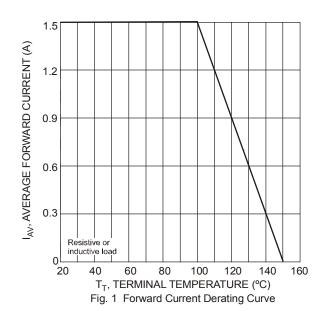
Thermal Characteristics

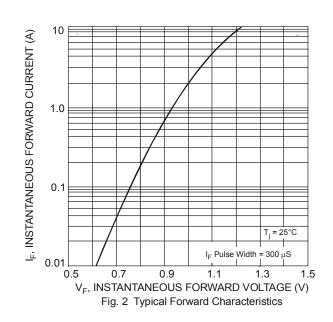
| Characteristic | Symbol | Value | Unit |
|---|-------------------|-------------|------|
| Typical Thermal Resistance, Junction to Terminal (Note 4) | $R_{\theta JT}$ | 20 | °C/W |
| Operating and Storage Temperature Range | $T_{J_i} T_{STG}$ | -65 to +150 | °C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

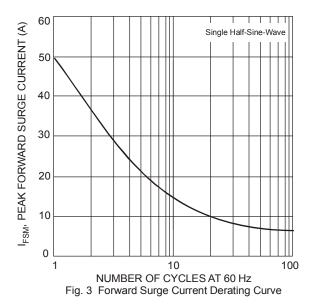
| Characteristic | | Symbol | Value | Unit |
|------------------------------------|-------------------------|----------------|-------|------|
| Forward Voltage | @ I _F = 1.5A | V_{FM} | 1.15 | V |
| Peak Reverse Current | @T _A = 25°C | le | 5.0 | uА |
| at Rated DC Blocking Voltage | $@T_A = 125^{\circ}C$ | IRM | 125 | μΛ |
| Typical Total Capacitance (Note 5) | | C _T | 20 | pF |

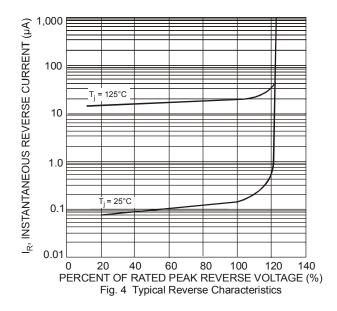
4. Thermal Resistance Junction to Terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink. Notes: 5. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.



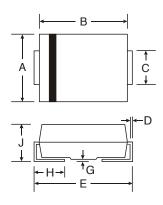








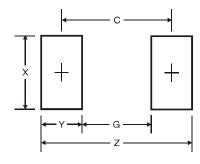
Package Outline Dimensions



| SMA | | | | | |
|----------------------|------|------|--|--|--|
| Dim | Min | Max | | | |
| Α | 2.29 | 2.92 | | | |
| В | 4.00 | 4.60 | | | |
| С | 1.27 | 1.63 | | | |
| D | 0.15 | 0.31 | | | |
| Е | 4.80 | 5.59 | | | |
| G | 0.05 | 0.20 | | | |
| Η | 0.76 | 1.52 | | | |
| J | 2.01 | 2.30 | | | |
| All Dimensions in mm | | | | | |

| SMB | | | | | |
|----------------------|------|------|--|--|--|
| Dim | Min | Max | | | |
| Α | 3.30 | 3.94 | | | |
| В | 4.06 | 4.57 | | | |
| C | 1.96 | 2.21 | | | |
| D | 0.15 | 0.31 | | | |
| Е | 5.00 | 5.59 | | | |
| G | 0.05 | 0.20 | | | |
| H | 0.76 | 1.52 | | | |
| J | 2.00 | 2.50 | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout



| SMA Dimensions | Value (in mm) |
|-------------------|---------------|
| Z | 6.5 |
| G | 1.5 |
| Х | 1.7 |
| Υ | 2.5 |
| С | 4.0 |

| SMB Dimensions | Value (in mm) | |
|-------------------|---------------|--|
| Z | 6.7 | |
| G | 1.8 | |
| Х | 2.3 | |
| Y | 2.5 | |
| С | 4.3 | |



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